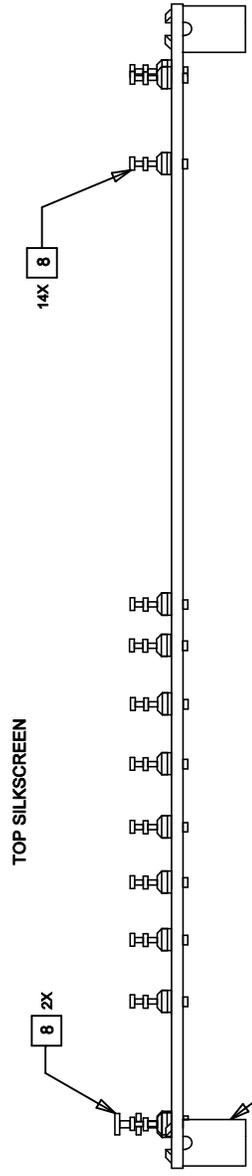
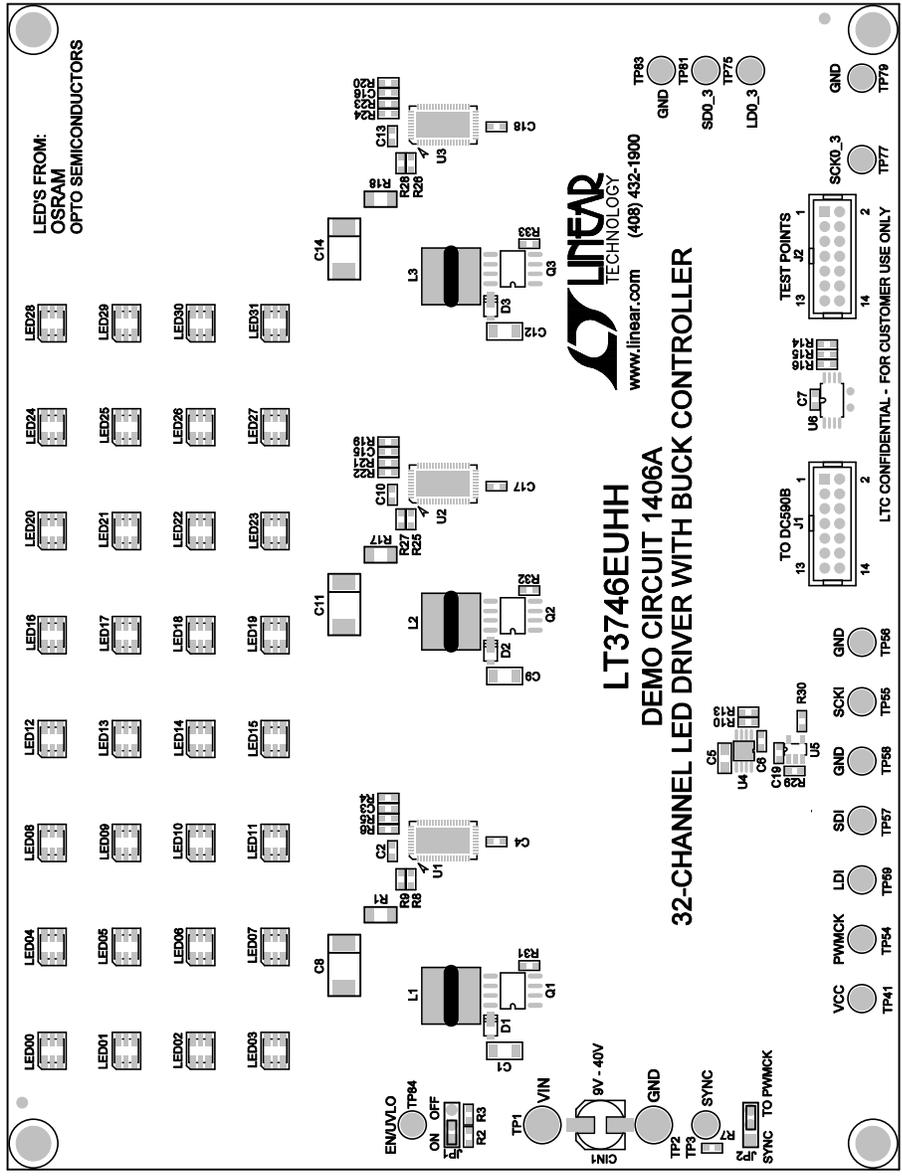


REVISION HISTORY				
ECO	REV	DESCRIPTION	APPROVAL	DATE
	1	PRODUCTION	WEI G.	12/14/10

- NOTES: UNLESS OTHERWISE SPECIFIED,
1. WORKMANSHIP SHALL BE IN ACCORDANCE WITH IPC-A-610.
 2. ASSEMBLY PROCESS SHALL INCLUDE: REFLOW SOLDER SMD SIDES. MAXIMUM SOLDER TEMPERATURE IS 240 DEGREES CELSIUS.
 3. PARTS TO OMIT WILL BE SPECIFIED ON THE BILL OF MATERIALS. LOCATIONS OF OMITTED PARTS SHALL BE FREE OF SOLDER. MASK THE SOLDER STENCIL WHERE SMT PARTS ARE OMITTED.
 4. INSTALL SHUNTS AS SHOWN ON ASSY DRAWING.
 5. DEPANELIZE BOARDS AFTER ASSEMBLY AND ROUTE-OUT THE BREAKOUT TABS ON FOUR SIDES OF THE BOARD EDGE.
 6. DO NOT APPLY ANY KIND OF ASSEMBLY STAMP OR QA STAMP TO ANY BOARD.
 7. INSTALL 4 STANDOFFS AT 4 LOCATIONS AS SHOWN.
 8. INSTALL TURRETS AS SHOWN.



APPROVALS		LTC CONFIDENTIAL - FOR CUSTOMER USE ONLY	
PCB DES.	MI	LINEAR TECHNOLOGY	1630 MCCARTHY BLVD MILPITAS, CA 95035 PH: (408) 432-1900
APP. ENG.	WEI G.	TITLE: TOP ASSEMBLY DRAWING, 32-CHANNEL LED DRIVER WITH BUCK CONTROLLER	
		SIZE	IC NO. LT3746EUHH
		N/A	REV 2
		SCALE: NONE	
		FILENAME: 1406A-2.PCB	
		SHT 1 of 1	